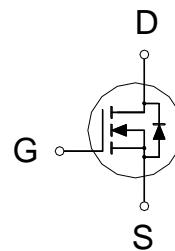


**NIKO-SEM**
**N-Channel Enhancement Mode  
Field Effect Transistor**
**PE8A8BA**  
**PDFN 3x3P**  
**Halogen-Free & Lead-Free**
**PRODUCT SUMMARY**

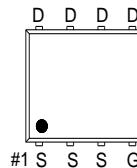
| $V_{(BR)DSS}$ | $R_{DS(on)}$ | $I_D$ |
|---------------|--------------|-------|
| 30V           | 3.7mΩ        | 75A   |

**Features**

- Pb-Free, Halogen Free and RoHS compliant.
- Low  $R_{DS(on)}$  to Minimize Conduction Losses.
- Ohmic Region Good  $R_{DS(on)}$  Ratio.
- Optimized Gate Charge to Minimize Switching Losses.

**Applications**

- Protection Circuits Applications.
- Logic/Load Switch Circuits Applications.


G. GATE  
D. DRAIN  
S. SOURCE

#1 S S S G  
100% UIS Tested  
100% Rg Tested
**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)**

| PARAMETERS/TEST CONDITIONS                     |                           | SYMBOL         | LIMITS     | UNITS |
|--|---------------------------|----------------|------------|-------|
| Drain-Source Voltage                           |                           | $V_{DS}$       | 30         | V     |
| Gate-Source Voltage                            |                           | $V_{GS}$       | $\pm 20$   | V     |
| Continuous Drain Current <sup>4</sup>          | $T_C = 25^\circ\text{C}$  | $I_D$          | 75         | A     |
|  | $T_C = 100^\circ\text{C}$ |                | 47         |       |
| Pulsed Drain Current <sup>1</sup>              |                           | $I_{DM}$       | 130        |       |
| Continuous Drain Current <sup>4</sup>          | $T_A = 25^\circ\text{C}$  | $I_D$          | 22         | A     |
|  | $T_A = 70^\circ\text{C}$  |                | 17         |       |
| Avalanche Current                              |                           | $I_{AS}$       | 47         |       |
| Avalanche Energy                               | $L = 0.05\text{mH}$       | $E_{AS}$       | 55         | mJ    |
| Power Dissipation                              | $T_C = 25^\circ\text{C}$  | $P_D$          | 37         | W     |
|  | $T_C = 100^\circ\text{C}$ |                | 15         |       |
| Power Dissipation <sup>3</sup>                 | $T_A = 25^\circ\text{C}$  | $P_D$          | 3.2        | W     |
|  | $T_A = 70^\circ\text{C}$  |                | 2.1        |       |
| Operating Junction & Storage Temperature Range |                           | $T_j, T_{stg}$ | -55 to 150 | °C    |

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**THERMAL RESISTANCE RATINGS**

| THERMAL RESISTANCE               |              | SYMBOL          | TYPICAL | MAXIMUM | UNITS  |
|----------------------------------|--------------|-----------------|---------|---------|--------|
| Junction-to-Ambient <sup>2</sup> | $t \leq 10s$ | $R_{\theta JA}$ |         | 38      | °C / W |
| Junction-to-Ambient <sup>2</sup> | Steady-State | $R_{\theta JA}$ |         | 80      |        |
| Junction-to-Case                 | Steady-State | $R_{\theta JC}$ |         | 3.3     |        |

<sup>1</sup>Pulse width limited by maximum junction temperature.<sup>2</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ C$ .<sup>3</sup>The Power dissipation is based on  $R_{\theta JA} t \leq 10s$  value.<sup>4</sup>Package limitation current is 33A.**ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ C$ , Unless Otherwise Noted)**

| PARAMETER                                     | SYMBOL        | TEST CONDITIONS  | LIMITS |      |           | UNIT      |
|---|---------------|--|--------|------|-----------|-----------|
|   |               |  | MIN    | TYP  | MAX       |           |
| <b>STATIC</b>                                 |               |  |        |      |           |           |
| Drain-Source Breakdown Voltage                | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu A$                                    | 30     |      |           | V         |
| Gate Threshold Voltage                        | $V_{GS(th)}$  | $V_{DS} = V_{GS}, I_D = 250\mu A$                                | 1.3    | 1.9  | 2.3       |           |
| Gate-Body Leakage                             | $I_{GSS}$     | $V_{DS} = 0V, V_{GS} = \pm 20V$                                  |        |      | $\pm 100$ | nA        |
| Zero Gate Voltage Drain Current               | $I_{DSS}$     | $V_{DS} = 24V, V_{GS} = 0V$                                      |        |      | 1         | $\mu A$   |
|   |               | $V_{DS} = 30V, V_{GS} = 0V, T_J = 55^\circ C$                    |        |      | 10        |           |
| Drain-Source On-State Resistance <sup>1</sup> | $R_{DS(ON)}$  | $V_{GS} = 4.5V, I_D = 13A$                                       |        | 3.2  | 6         | $m\Omega$ |
|   |               | $V_{GS} = 10V, I_D = 13A$  |        | 2.3  | 3.7       |           |
| Forward Transconductance <sup>1</sup>         | $g_{fs}$      | $V_{DS} = 5V, I_D = 13A$   |        | 75   |           | S         |
| <b>DYNAMIC</b>                                |               |  |        |      |           |           |
| Input Capacitance                             | $C_{iss}$     | $V_{GS} = 0V, V_{DS} = 15V, f = 1MHz$                            |        | 1915 |           | pF        |
| Output Capacitance                            | $C_{oss}$     |  |        | 1096 |           |           |
| Reverse Transfer Capacitance                  | $C_{rss}$     |  |        | 79   |           |           |
| Gate Resistance                               | $R_g$         | $V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$                             |        | 1    |           | $\Omega$  |
| Total Gate Charge <sup>2</sup>                | $Q_g$         | $V_{DS} = 15V, V_{GS} = 10V, I_D = 13A$                          |        | 34   |           | nC        |
|   |               |  |        | 17   |           |           |
| Gate-Source Charge <sup>2</sup>               | $Q_{gs}$      |  |        | 4.4  |           |           |
| Gate-Drain Charge <sup>2</sup>                | $Q_{gd}$      |  |        | 6.4  |           |           |
| Turn-On Delay Time <sup>2</sup>               | $t_{d(on)}$   |  |        | 12   |           |           |
| Rise Time <sup>2</sup>                        | $t_r$         |  |        | 62   |           |           |
| Turn-Off Delay Time <sup>2</sup>              | $t_{d(off)}$  | $V_{DS} = 15V, I_D \approx 13A, V_{GS} = 10V, R_{GEN} = 6\Omega$ |        | 45   |           | nS        |
| Fall Time <sup>2</sup>                        | $t_f$         |  |        | 88   |           |           |

**NIKO-SEM****N-Channel Enhancement Mode  
Field Effect Transistor****PE8A8BA  
PDFN 3x3P  
Halogen-Free & Lead-Free****SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T<sub>J</sub> = 25 °C)**

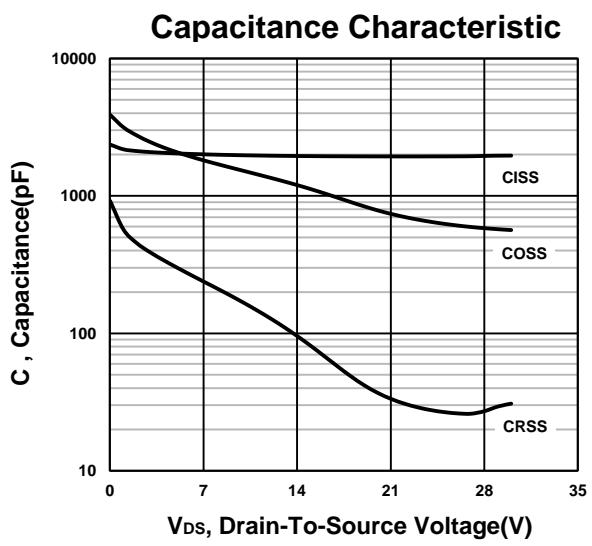
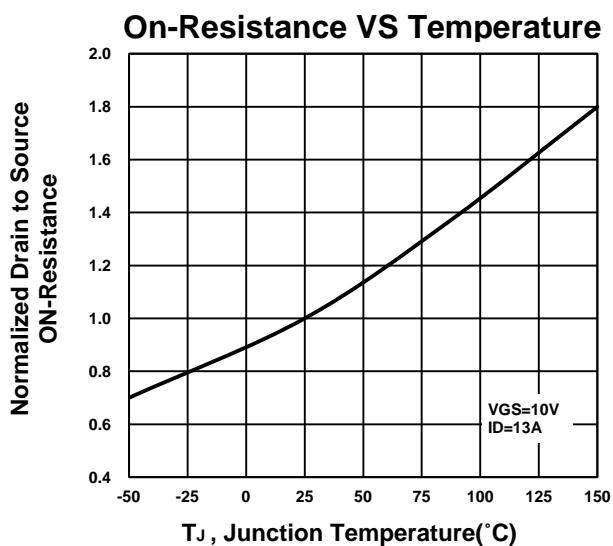
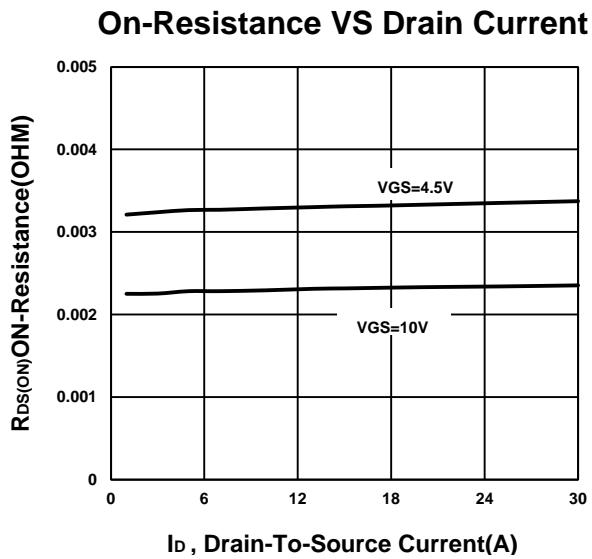
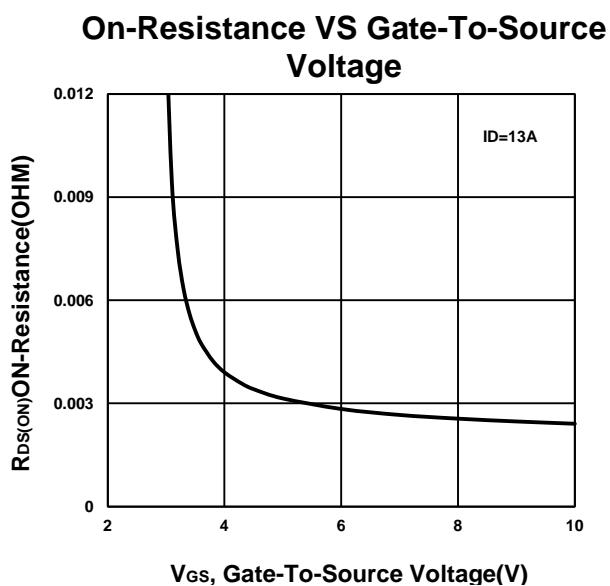
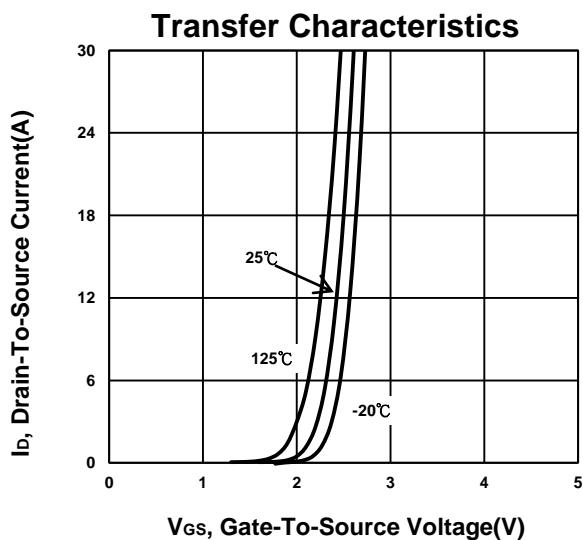
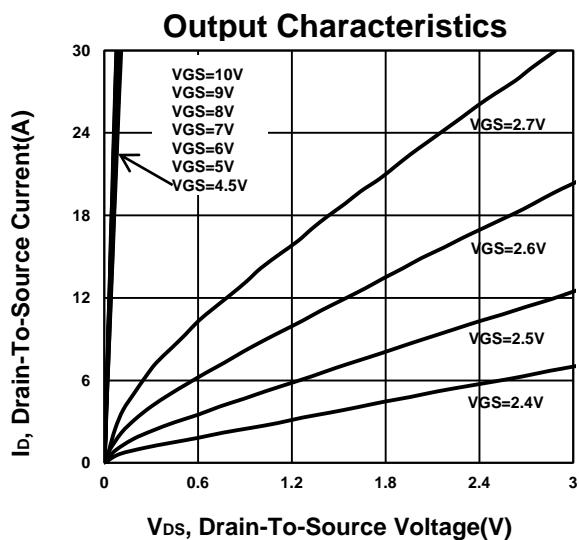
|                              |                 |   |  |    |     |    |
|------------------------------|-----------------|---|--|----|-----|----|
| Continuous Current           | I <sub>S</sub>  |   |  |    | 30  | A  |
| Forward Voltage <sup>1</sup> | V <sub>SD</sub> | I <sub>F</sub> = 13A, V <sub>GS</sub> = 0V            |  |    | 1.2 | V  |
| Reverse Recovery Time        | t <sub>rr</sub> | I <sub>F</sub> = 13A, dI <sub>F</sub> /dt = 100A / μS |  | 31 |     | nS |
| Reverse Recovery Charge      | Q <sub>rr</sub> |   |  | 22 |     | nC |

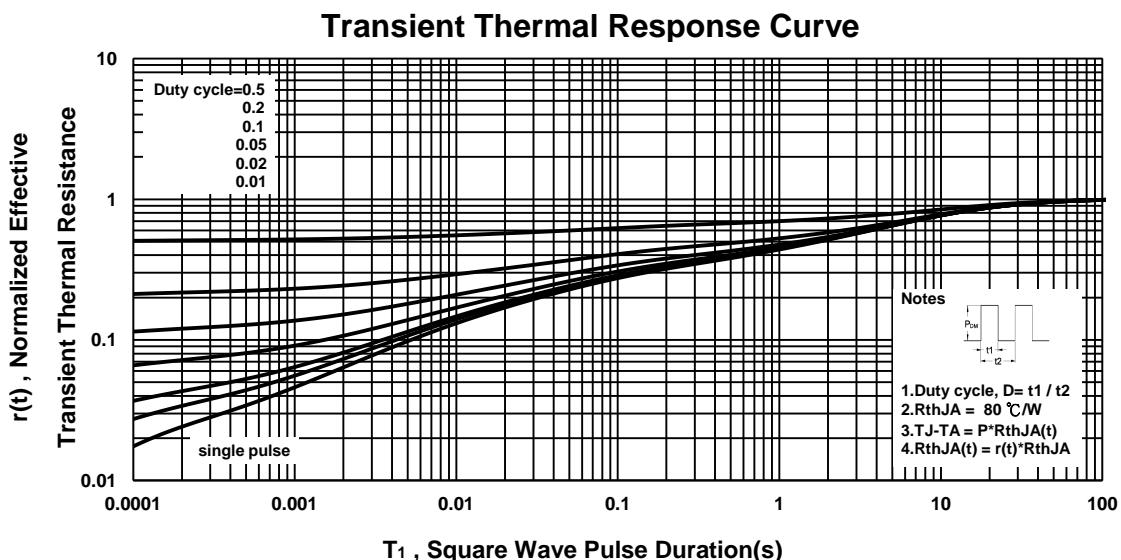
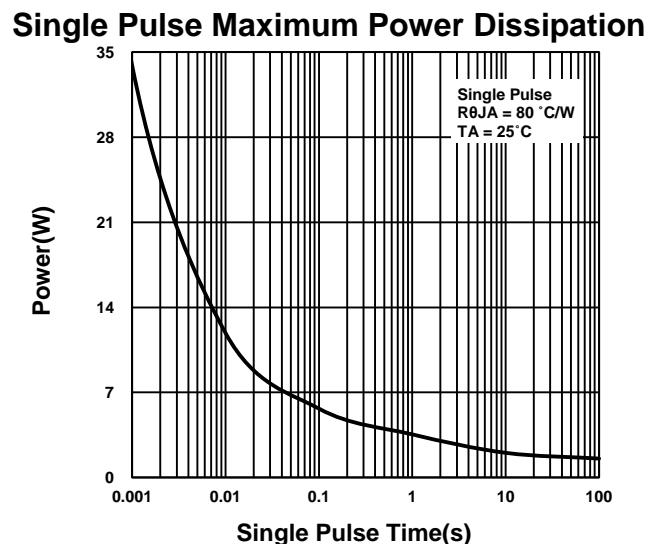
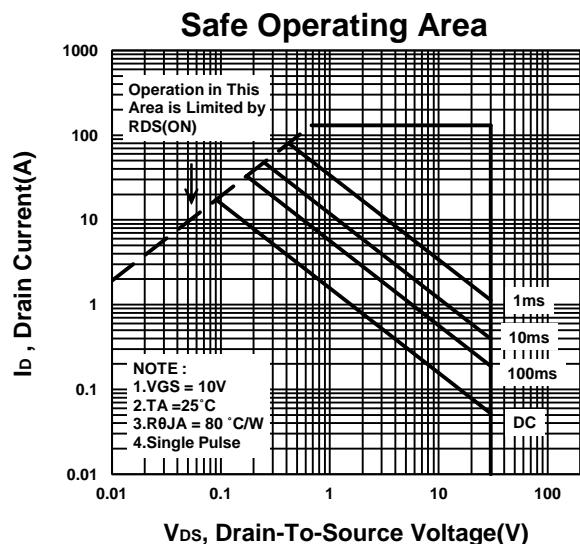
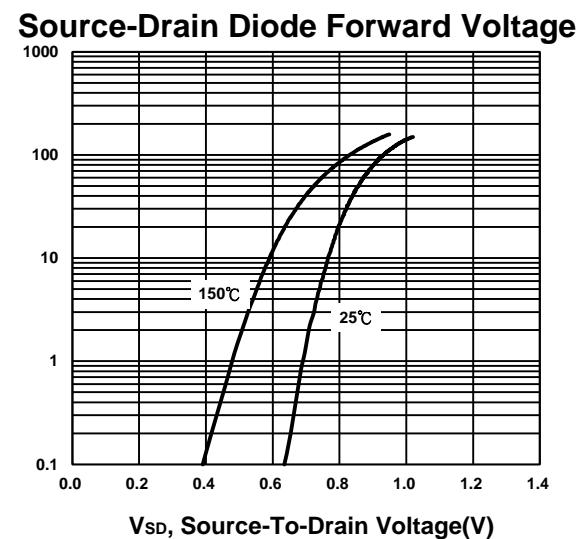
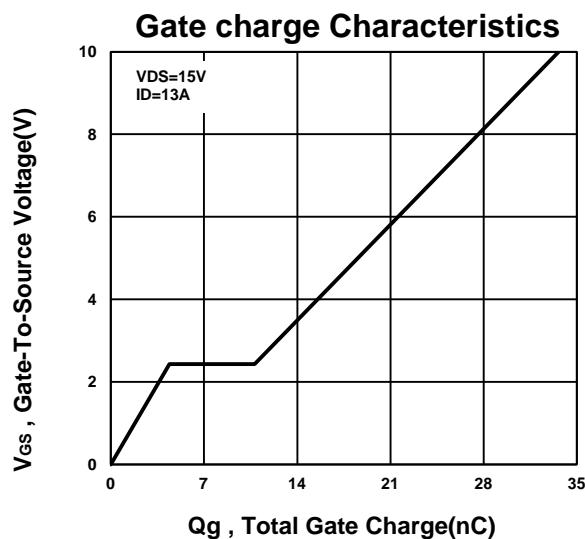
<sup>1</sup>Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.<sup>2</sup>Independent of operating temperature.

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